

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: B. GHYSELEN et al

Confirmation No. 2668

Application No: 10/726,039

Group Art Unit: 2812

Filing Date: December 1, 2003

Examiner:

For: RECYCLING OF A WAFER COMPRISING

Atty. Docket No.: 4717-8600

A BUFFER LAYER AFTER HAVING

SEPARATED A THIN LAYER THEREFROM BY

MECHANICAL MEANS

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Pursuant to applicants' duty of disclosure under 37 C.F.R. 1.56, applicants submit herewith twelve(12) references for the Examiner's review and consideration. These references were cited in the Preliminary Search Report and a copy is enclosed.

These references are listed on the enclosed Form PTO-1449. It is respectfully requested that these references be made of record in this application by the Examiner's completion and return of the PTO Form 1449.

No fee is believed to be due for the filing of this statement as it is being submitted prior to an initial office action for this application. Should any fees be required, however, please charge such fees to Winston & Strawn LLP Deposit Account No. 50-1814.

Date:

Allan A. Fanucci

(Reg. No. 30,256)

WINSTON & STRAWN CUSTOMER NO. 28765

Respectfully submitted,

(212) 294-3311

Enclosures

NY:858379.1



ST OF REFERENCES CITED BY APPLICANT

(Use several sheets if necessary)

ATTY. DOCKET NO.:

4717-8600

APPLICANT:

Bruno GHYSELEN et al.

Filing date:

December 1, 2003

APPLICATION SERIAL NO.:

10/726, 039

GROUP:

2812

			II S	PATENT D	OCUMENTS	1, 2000	1		
*EXAMINER INITIAL			DATE		NAME		SUBCLASS	FILING D	ATE IF
	AA	5,882,987	3/1999	Srikrishn	Srikrishnan		458		
	AB	6,284,628 B1	9/2001	Kuwahara	a et al.	438	459		
	AC	6,306,729 B1	10/2001	Sakaguchi et al		438	458		
	AD	6,326,279 B1	12/2001	Kakizaki	et al.	438	406		
	AE	6,468,923 B1	12/2002	Yonehara	Yonehara et al.		761		
	AF	2002/0072130 A1	6/2002	Cheng et	Cheng et al.		10		
-			FORE	IGN PATENT	DOCUMENTS	•			
		DOCUMENT NUMBER	DATE		COUNTRY		SUBCLASS	TRANSI	ATION
			211.2	333				YES	NO
	AG	EP 0 955 671 A1	11/1999	Europe				Х	
	АН	EP 1 039 513 A2	9/2000	Europe				х	
	AI	EP 0 926 709 A2	6/1999	Europe				x	
	AJ	WO 01/11930 A2	2/2001	PCT				x	
		OTHER RE	FERENCES (//	ncluding Auth	nor, Title, Date, Pertin	ent Pages, Etc.)			
	AK	L. J. Huang et al, "Shigh-performance 1267-1269 (2001)		-			•		or
	AL	Q. Y. Tong et al "Extracts of "Semi-conductor on wafer bonding", Science and Technology, Interscience Technology, Wiley Interscience publication, Johnson Wiley & Sons, Inc.							
	AM								
		EXAMINER		I	DATE CONSIDEREI)			

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.